Resistors

Metal Glaze[™] Cylindrical Small Size Power Resistor

CHP1X Series

- 0.1 ohm to 10K ohm
- Outstanding surge capacity
- 1W in a 1/2W package (2010 footprint) 150°C maximum operating temperature

OBSOLETE



All Pb-free parts comply with EU Directive 2011/65/EU amended by (EU) 2015/863 (RoHS3)

Electrical Data

Industry Footprint	IRC Type	Maximum Power Rating	Working Voltage ¹	Maximum Voltage	Resistance Range (ohms)²	Tolerance (±%)²	TCR (±%)³	Product Category	
2010	CHP 1X	1W @ 70°C	300	600	0.1 to 0.99	1, 2, 5	100	Low Range	
					1.0 to 10K	1, 2, 5	50, 100	Standard	
¹ Not to exceed $\sqrt{P \times R}$ ² Consult factory for tighter TCR, tolerance, or resistance values									

Environmental Data

Characteristics	Maximum Change	Test Method		
Temperature Coefficient	As specified	MIL-R-55342E Par 4.7.9 (-55°C + 125°C)		
Thermal Shock	±0.5% + 0.01 ohm	MIL-R-55342E Par 4.7.3 (-65°C + 150°C, 5 cycles)		
Low Temperature Operation	±0.25% + 0.01 ohm	MIL-R-55342E Par 4.7.4 (-65°C @ working voltage)		
Short Time Overload	$\pm 0.5\%$ + 0.01 ohm $\pm 1\%$ for R>100K ohm	MIL-R-55342E Par 4.7.5 2.5 x $\sqrt{P x R}$ for 5 seconds		
High Temperature Exposure	±0.5% + 0.01 ohm	MIL-R-55342E Par 4.7.6 (+150°C for 100 hours)		
Resistance to Bonding Exposure	±0.25% + 0.01 ohm	MIL-R-55342E Par 4.7.7 (Reflow soldered to board at 260°C for 10 seconds)		
Solderability	95% minimum coverage	MIL-STD-202, Method 208 (245°C for 5 seconds)		
Moisture Resistance	±0.5% + 0.01 ohm	MIL-R-55342E Par 4.7.8 (10 cycles, total 240 hours)		
Life Test	±0.3% + 0.01 ohm	MIL-R-55342E Par 4.7.10 (2000 hours @ 70°C intermittent)		
Terminal Adhesion Strength	±1% + 0.01 ohm no mechanical damage	1200 gram push from underside of mounted chip for 60 seconds		
Resistance to Board Bending	±1% + 0.01 ohm no mechanical damage	Chip mounted in center of 90mm long board, deflected 5mm so as to exert pull on chip contacts for 10 seconds		

General Note

TT Electronics reserves the right to make changes in product specification without notice or liability. All information is subject to TT Electronics' own data and is considered accurate at time of going to print.

www.ttelectronics.com/resistors



Metal Glaze[™] thick film element fired at 1000°C to solid ceramic substrate



CHP1X Series

Power Derating Curve



Repetitive Surge Curve

OBSOLETE



Non/Low Repetitive Surge Curve



Ordering Data



Temperature Rise Chart



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